

DDR4 DIMM

TE Internal #: 2309410-2 SO DIMM Sockets, Small Outline (SO), Stack Height .205 in [5.2 mm], Right Angle Module Orientation, 260 / 200 Position, DDR4 DIMM

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DRAM Type: Small Outline (SO) Stack Height: 5.2 mm [.205 in] Module Orientation: Right Angle Number of Positions: 200, 260 Centerline (Pitch): .5 mm [.02 in]

All DDR4 SO DIMM Sockets (39)

Features

Product Type Features

Connector System

Cable-to-Board

Connector & Contact Terminates To	Printed Circuit Board
DRAM Type	Small Outline (SO)
Configuration Features	
Number of Keys	1
Number of Rows	2
Module Orientation	Right Angle
Number of Positions	200, 260
Electrical Characteristics	
DRAM Voltage	1.2 V
Signal Characteristics	
SGRAM Voltage	1.2 V
Body Features	
Ejector Location	Both Ends
Retention Post Material	Copper Alloy

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Latch Material	High Temperature Thermoplastic
Retention Post Location	Both Ends
Ejector Type	Locking
Connector Profile	Low
Contact Features	
Memory Socket Type	Memory Card
Contact Underplating Material	Nickel
PCB Contact Termination Area Plating Material	Gold Flash
Contact Base Material	Copper Alloy
Contact Current Rating (Max)	.5 A
Contact Mating Area Plating Material	Gold
Contact Mating Area Plating Material Thickness	.127 μm[5 μin]
Termination Features	
Insertion Style	Cam-In
Termination Method to Printed Circuit Board	Surface Mount
Mechanical Attachment	
Mating Alignment Type	Reverse Keying
PCB Mount Retention	With
PCB Mount Retention Type	Solder Peg
Connector Mounting Type	Board Mount
Housing Features	
Housing Material	High Temperature Thermoplastic
Housing Color	Black
Centerline (Pitch)	.5 mm[.02 in]
Dimensions	
Stack Height	5.2 mm[.205 in]
Row-to-Row Spacing	8.2 mm[.322 in]
Jsage Conditions	
Operating Temperature Range	-55 - 85 °C[-67 - 185 °F]
Operation/Application	

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UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Quantity	800
Packaging Method	Tape & Reel
Product Compliance For compliance documentation, visit the product page on TE.com>	
EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JAN 2024 (240) Candidate List Declared Against: JAN 2021 (211) Does not contain REACH SVHC
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Not reviewed for solder process capability

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts



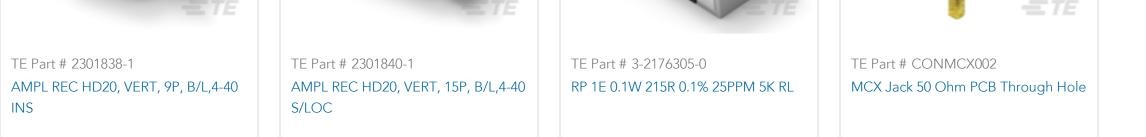
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Also in the SeriesDDR4 DIMMImage: Dimensional systemImage: Dimensiona

Customers Also Bought







Documents

Product Drawings DDR4 SODIMM 260P 5.2H RVS

English

CAD Files

3D PDF

3D

SO DIMM Sockets, Small Outline (SO), Stack Height .205 in [5.2 mm], Right Angle Module Orientation, 260 / 200 Position, DDR4 DIMM



Customer View Model

ENG_CVM_CVM_2309410-2_1.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_2309410-2_1.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_2309410-2_1.3d_stp.zip

English

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Product Specifications Application Specification

English